

2826



TRANSMITTAL LETTER
(General - Patent Pending)

Docket No.
END920000149US1

In Re Application Of: **Adae-Amoakoh et al.**

Serial No.
09/827,014

Filing Date
4/5/01

Examiner
Andujar, Leonardo

Group Art Unit
2826

Title: **METHOD AND STRUCTURE FOR ECONOMICAL HIGH DENSITY CHIP CARRIER**

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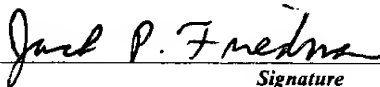
TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Response to Restriction

in the above identified application.

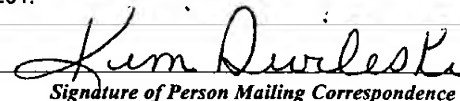
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I certify that this document and fee is being deposited on **6/25/02** with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.


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